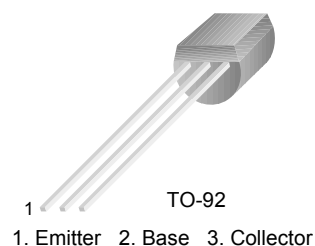


# 2N6517

## NPN Epitaxial Silicon Transistor

### Features

- High Voltage Transistor
- Collector Dissipation:  $P_C(\text{max}) = 625\text{mW}$
- Complement to 2N6520
- Suffix “-C” means Center Collector (1. Emitter 2. Collector 3. Base)



### Absolute Maximum Ratings $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector-Base Voltage	2N6517 350	V
		2N6517C 400	V
$V_{CEO}$	Collector-Emitter Voltage	2N6517 350	V
		2N6517C 400	V
$V_{EBO}$	Emitter-Base Voltage	6	V
$I_C$	Collector Current	500	mA
$P_C$	Collector Power Dissipation	625	mW
$T_J$	Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature	-55 ~ 150	$^\circ\text{C}$

### Electrical Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage				
	2N6517 2N6517C	I <sub>C</sub> = 100μA, I <sub>E</sub> = 0 I <sub>C</sub> = 100μA, I <sub>E</sub> = 0	350 400		V V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage *				
	2N6517 2N6517C	I <sub>C</sub> = 1mA, I <sub>B</sub> = 0 I <sub>C</sub> = 1mA, I <sub>B</sub> = 0	350 400		V V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> = 10μA, I <sub>C</sub> = 0	6		V
I <sub>CBO</sub>	Collector Cut-off Current	V <sub>CB</sub> = 250V, I <sub>E</sub> = 0		50	nA
I <sub>EBO</sub>	Emitter Cut-off Current	V <sub>EB</sub> = 5V, I <sub>C</sub> = 0		50	nA
h <sub>FE</sub>	DC Current Gain *				
	2N6517/2N6517C	V <sub>CE</sub> = 10V, I <sub>C</sub> = 1mA	20		
	2N6517/2N6517C	V <sub>CE</sub> = 10V, I <sub>C</sub> = 10mA	30		
	2N6517/2N6517C	V <sub>CE</sub> = 10V, I <sub>C</sub> = 30mA	30	200	
	2N6517/2N6517C	V <sub>CE</sub> = 10V, I <sub>C</sub> = 50mA	20	200	
	2N6517/2N6517C	V <sub>CE</sub> = 10V, I <sub>C</sub> = 100mA	15		
	2N6517C	V <sub>CE</sub> = 10V, I <sub>C</sub> = 5mA	50	200	

**Electrical Characteristics** (Continued)  $T_a = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max.	Units
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 10\text{mA}, I_B = 1\text{mA}$		0.3	V
		$I_C = 20\text{mA}, I_B = 2\text{mA}$		0.35	V
		$I_C = 30\text{mA}, I_B = 3\text{mA}$		0.5	V
		$I_C = 50\text{mA}, I_B = 5\text{mA}$		1	V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = 10\text{mA}, I_B = 1\text{mA}$		0.75	V
		$I_C = 20\text{mA}, I_B = 2\text{mA}$		0.85	V
		$I_C = 30\text{mA}, I_B = 3\text{mA}$		0.9	V
$C_{ob}$	Output Capacitance	$V_{CB} = 20\text{V}, I_E = 0, f = 1\text{MHz}$		6	pF
$f_T$	Current Gain Bandwidth Product *	$I_C = 10\text{mA}, V_{CE} = 20\text{V}, f = 20\text{MHz}$	40	200	MHz
$V_{BE(on)}$	Base-Emitter On Voltage	$I_C = 100\text{mA}, V_{CE} = 10\text{V}$		2	V

\* Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$

## Typical Performance Characteristics

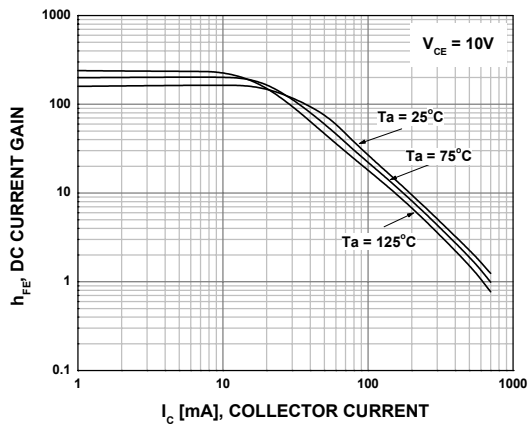


Figure 1. DC Current Gain

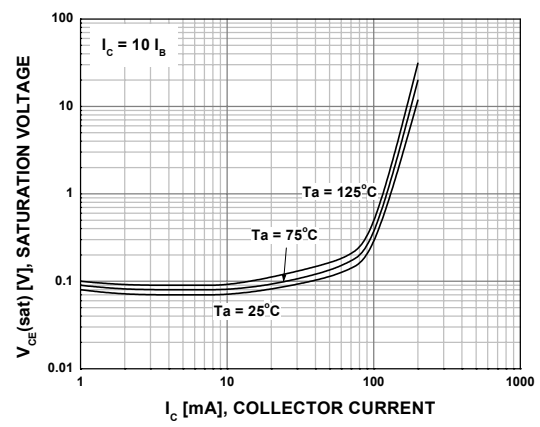


Figure 2. Saturation Voltage

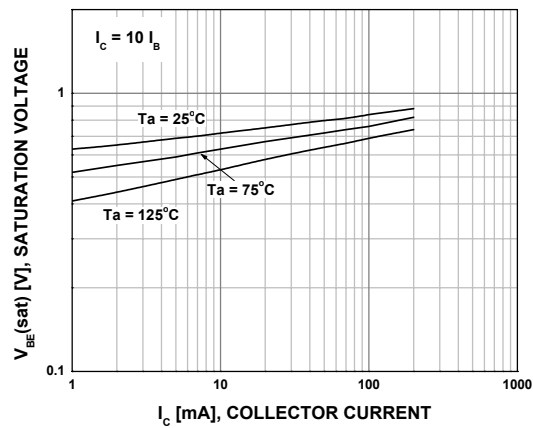


Figure 3. Saturation Voltage

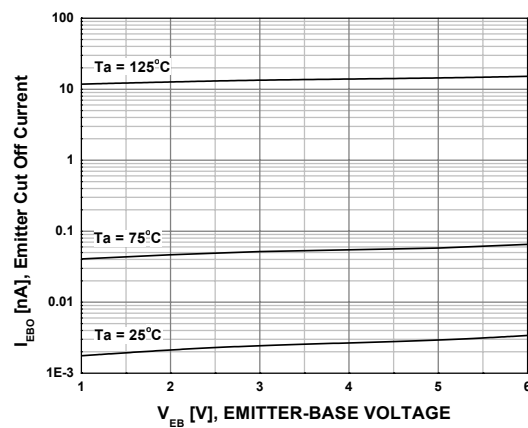


Figure 4. Emitter Cut Off Current

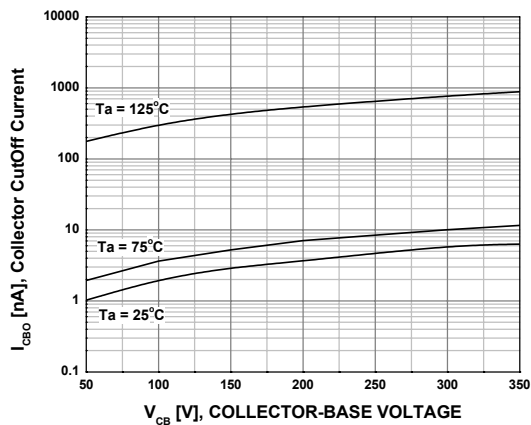


Figure 5. Collector CutOff Current

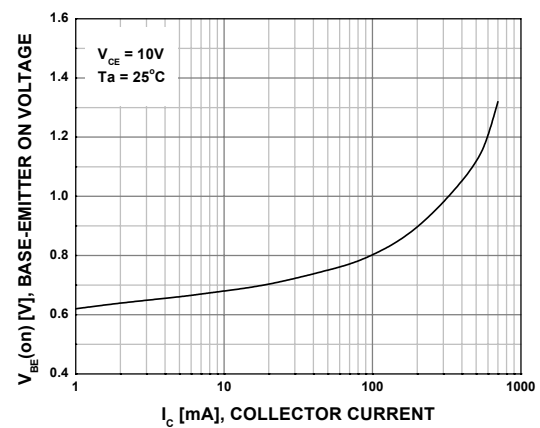


Figure 6. Base-Emitter On Voltage

# Typical Performance Characteristics (Continued)

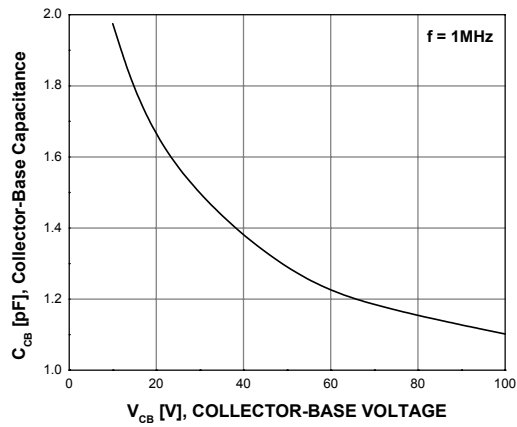


Figure 7. Output Capacitance

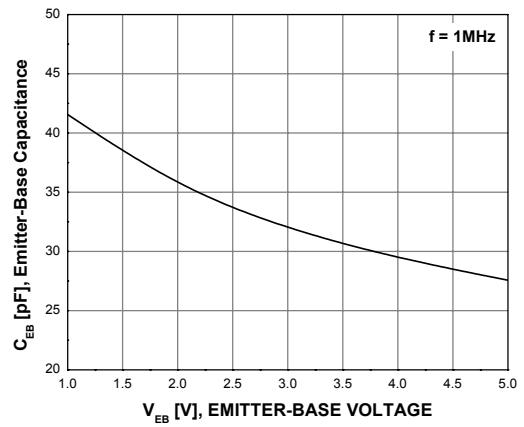


Figure 8. Input Capacitance

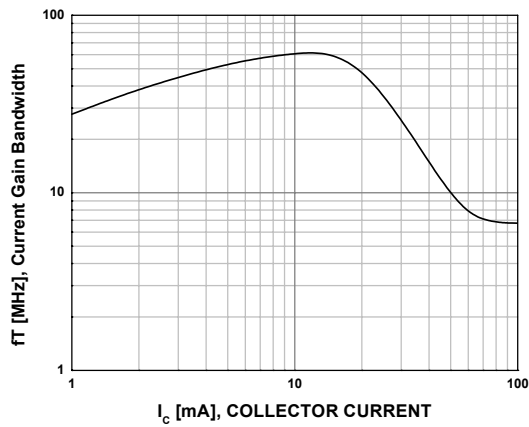


Figure 9. Current Gain Bandwidth Product

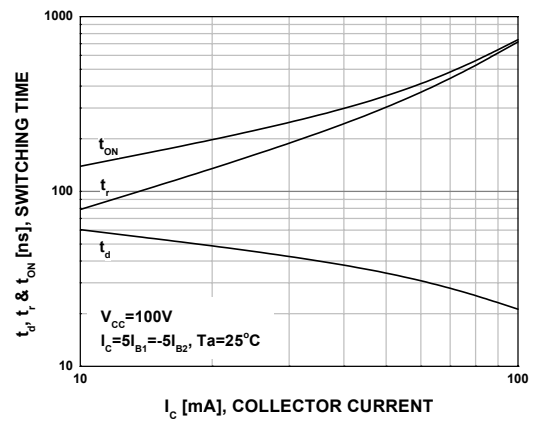


Figure 10. Resistive Load Switching

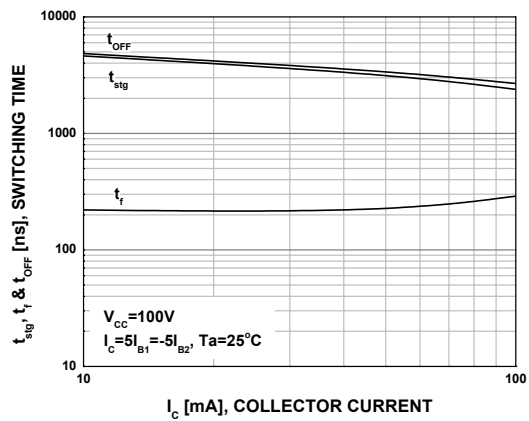
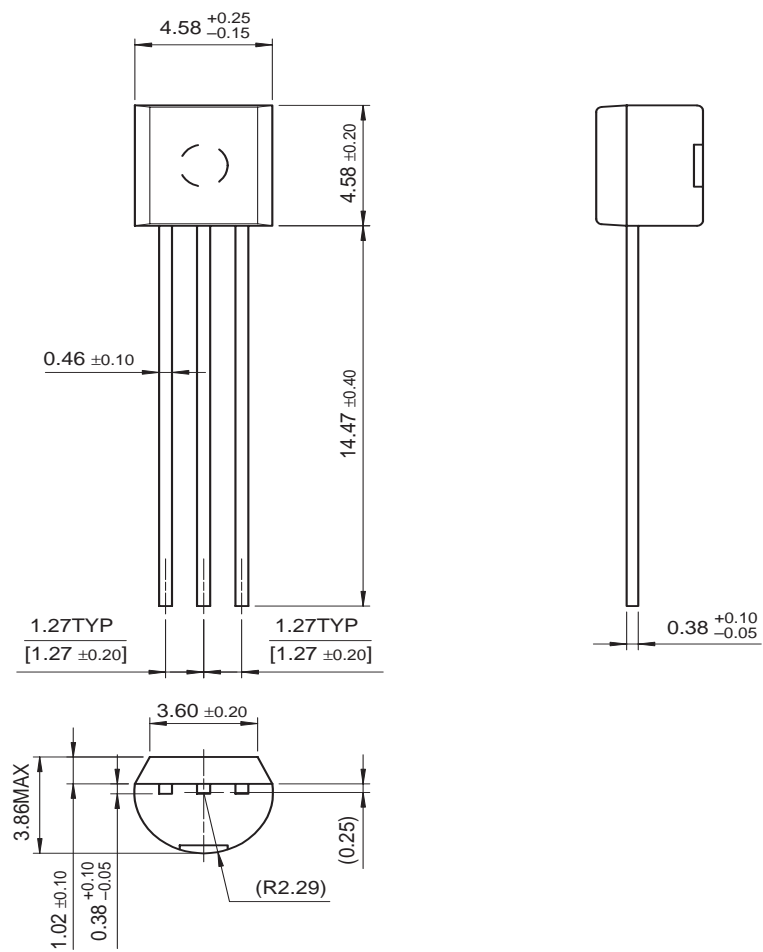


Figure 11. Resistive Load Switching

# Physical Dimensions

## TO-92



Dimensions in Millimeters



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